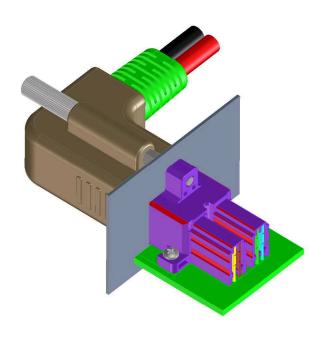
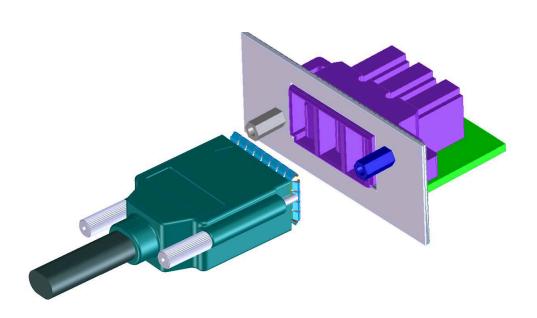


GUARDIAN CONNECTOR SYSTEM





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PRODUCT SPECIFICATION

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- 1.0 SCOPE
- 2.0 SUMMARY OF RESULTS
- 3.0 DOCUMENTS & SPECIFICATIONS
 - 3.1 TestingProcedure&Sequences
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 - 4.2 Free HangingLoad Test
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- 5.1.1 Crimp Stress AcceptanceCriteria
 - 5.2 Electrical Performance and Rating
 - **5.3 Temperature Rise CurrentCharts**
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- 7.0 TEST RESULTS, ENVIRONMENTAL TESTING
- **8.0 SOLDER PROFILE**
- 9.0 SAFETY AGENCY RATING APPROVAL
 - 9.1 C.S.A. File Number– LR 19980 9.2 U.L. File Number– E29179

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PRODUCT SPECIFICATION

1.0 SCOPE

The specification covers the test sequence performance of the high current wire-to-board interconnect system:

2.0 SUMMARY OF RESULTS

The product meets all the Mechanical, Electrical and Environmental test criteria at component and harness level, and is considered a qualified product.

3.0 DOCUMENTS AND SPECIFICATIONS

3.1 Testing Procedure & Sequences:

Item	Test Report	Test Description
1	TR-1.8582	QualificationTest Per EIA-364-1000 Group 1,2,3, & 5
2	TR-1.8583	Electrical Crimp Qualification of 8 & 10 AWG
3	TR-1.8584	Construction analysis
4	TR-1.8733	Harness Pull Force and Torque Retention Test, in mated condition
5	TR-1.8570	T-Rise Test per EIA-364B
6	TR-1.8595	Normal Force Analysis
7	63801-7900	Mech. Crimp Qualification
8		EIA-364-1000 Group 4 Mixed Flowing Gases
9	TR-1.8931	Hot-mating/Resistance to Arc

3.2 Other Documents:

See series specific sales drawings for additional information.

HEADER	2 CKT	46817 SERIES
	3 CKT	46817 SERIES
HARNESS	2 CKT	68790 SERIES
HARNESS	3 CKT	111119 SERIES

Ref. terminal in harness - 46819-****

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PRODUCT SPECIFICATION

4.0 MECHANICAL PERFORMANCE

4.1 MECHANICAL PERFORMANCE AT COMPONENT LEVEL

EQUIPME	NT/FIXTURE	TEST DESCRIPTION			TEST	RES	ULT			
Forc	e Gauge	Terminal Retention to the Housing (Header) per EIA-364-29		Avg.(3 CKT) St. Dev.				13.83 N 0.56		
Sol	der Pot	Solderability Test (Header) per EIA- 364-52	Meets 95% min Coverage							
X-Ray F	luoroscope	Plating Verification (Plug & Crimp Terminal)	Meets Specification							
Ir	nstron	Normal Force per EIA-364-04, Method	3	3.90 g (A	.vg)/Beam	@ 0.	45 mm	defle	ction	
			1 st Cycle	In	sertion Force (Newtons)			Withdrawal Force (Newtons)		
Instron	Insertion/Withdrawal Force		1 ckt	2 ckt	3 c	kt	1 ckt	2ckt	3 ckt	
		Min	7.23	11.27	26.	71 (6.86	10.31	28.21	
	iotron	perEIA-364-13	Max	9.23	19.11	36.	60	8.53	19.12	34.39
			Avg	7.92	15.60	31.0	06	7.36	15.87	30.75
			Std Dev	0.68	3.15	3.7	70	0.68	3.85	2.20
Forc	e Gauge	Crimp Terminal Retention to Housing				N/A ermol	d			
	*On 3	3 ckt configuration, 1 of th	e ckts is ground	(pre-mate	e) Above for	rces a	re peak	force.		
							6 AV	NG	8 AWG	10 AW
Coro	o Cougo	Crima Tarminal to Wi	ro Dull Force (II	~~\	Avg (lbs)		31	5	302	216
FOIC	e Gauge	Crimp Terminal to Wi	re Pull Force (II	ນຮ)	Std De	: V	11.	17	5.06	4.45
			Failure Mode		Wir Pull-		Wire Break	Wire Break		
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4.2 MECHANICAL TEST: FREE HANGING LOAD TEST (MATED CONDITION - 2.5 M CABLE)

EQUIPMENT/FIXTURE	TEST DESCRIPTION	TEST RESULT
Rigid Fixture	100 Newtons Weight Straight InlineLoading For 60 Seconds (See Figure 1)	Visually Inspected No Damage
Rigid Fixture	200 Newtons Weight at 90 degrees Loading For 60 Seconds (Both North-South and East-West directions – see Figure 2)	Visually Inspected No Damage
Rigid Fixture	150 Newtons Weight 45 degreesloading For 60 Seconds (See Figure 3)	Visually Inspected No Damage







Fig. 2 Fig. 1

5.0 ELECTRICAL REQUIREMENTS

5.1 CRIMP STRESS TEST-MILLIVOLT DROP

CRIMP WIRE SIZE	TEST DESCRIPTION	SAMPLE SIZE	ΔRESULT
	Initial Voltage DropThermal ShockVibration	Qty 75 Nominal Crimp Height (Grp A)	0.30 Millivolts $\sigma = 0.053$
8 AWG	 Accelerated Aging Final Voltage Drop End Testing 	Qty 30 Upper Crimp Height (Grp. B)	0.20 Millivolts $\sigma = 0.045$
	Applied 10 Amps See Figure 4 & 5 for test setup and measurements	Qty 30 Lower Crimp Height (Grp C)	0.45 Millivolts $\sigma = 0.101$

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10 AWG	Initial Voltage DropThermal ShockVibration	Qty 75 Nominal Crimp Height. (Grp A)	0.66 Millivolts $\sigma = 0.118$
	 Accelerated Aging Final Voltage Drop End Testing 	Qty 30 Upper Crimp Height (Grp. B)	0.76 Millivolts $\sigma = 0.177$
	Applied 10 Amps See Figures 4 & 5 for test set-up and measurements	Qty 30 Lower Crimp Height (Grp C)	0.56 Millivolts σ =0.120

^{*} Acceptance criteria appears on page 4 of this specification

5.1.1 CRIMP STRESS ACCEPTANCE CRITERIA

 Δ = Change in Millivolts after test sequence

 σ = Standard Deviation

Requirements to pass 8 AWG wire:

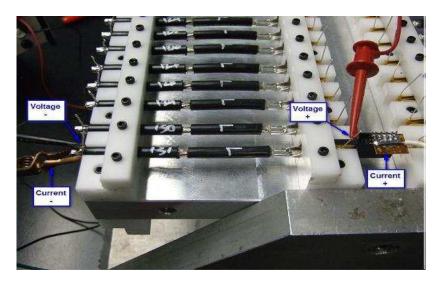
 Δ = Average Change + 5.46 σ </= 1.33 Millivolt(Group A)

 Δ = Average Change + 4.21 σ </= 1.33 Millivolt(Group B & C)

Requirements to pass 10 AWG wire:

 Δ = Average Change + 5.46 σ </= 1.68 Millivolt (Group A)

 Δ = Average Change + 4.21 σ </= 1.68 Millivolt (Group B & C)



Test Set-up Fig. 4

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PRODUCT SPECIFICATION

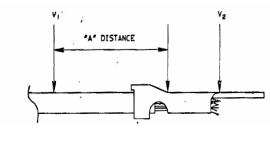


Fig. 5 Voltage Drop

The specimen wire gauge used for testing was 10 AWG. The specimen was powered at 10 amps. Voltage drop measurements were taken after 30 seconds across individual circuits at the applied current. Themaximum allowable distance 'A' between the voltage probes was 100 mm. The open circuit voltage may not exceed 0.05 volts. Instrumentation shall be such that the measured value is accurate to +/- 5%.

5.2ELECTRICAL PERFORMANCE & RATING:

5.2.1 VOLTAGE:

Voltage: 600 V Max.

Connector Rating per UL-1977

Connector voltage rating meets the connector approval level defined by UL 1977, Sect. 11 for spacing's per table 11.1. Example: 1.2 mm for \geq 250 volt, 3.2 mm for \leq 250 volt.

Exception taken for spacing less than those specified are permitted if the device complies with the requirements in the dielectric voltage withstanding test per Sect. 17.

Application Voltage Guideline

For application voltage requirements per UL-60950 or other standards, the creepage& clearance also needs to be determined based upon pads/traces on the pcb. For example, per UL-60950-1 (Table 2N) (UL/ANSI Standard-Safety for Information Technology Equipment Requirements) below are the minimum creepage distances required:

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		POLLUTION	DEGREE 2			
RMS Working	MATERIAL GROUP					
Voltages Up to & Including:	PRINTED CIRCUIT BOARDS	OTHER MATERIALS				
(V)	I, II, IIIa, IIIb (mm)	l (mm)	II (mm)	IIIa, IIIb (mm)		
50	.04	0.6	0.85	1.2		
125	.25	0.75	1.05	1.5		
250	1.0	1.25	1.8	2.5		
320	1.6	1.6	2.2	3.2		
630	3.2	3.2	4.5	6.3		

- *Pollution degree 2 is a typical environment for electrical connectors.
- **Material Group depends on the comparative tracking index (CTI) and is classified as follows:

Material Group I $CTI \ge 600$ Material Group II $400 \le CTI < 600$ Material Group IIIA $175 \le CTI < 400$ Material Group IIIB $100 \le CTI < 175$

5.2.2 OPERATING TEMPERATURE

Operating temperature(including T-rise from applied current) is -40°C to +105°C. Field temperatures and field life: Tested per EIA-364-1000.01 (see pg 14) to meet field temperature of 65° C for 10 years or 85° C for 3 years per Tables 8 & 9 application guideline.

5.2.3 CURRENT: (See Item #4)

Current rating is application dependent. The ratings listed in the chart are per EIA364-70 and should be used as a guideline only. Appropriate de-rating is required per ckt size, ambient conditions, copper trace size on the PCB, gross heating from adjacent modules or components, and other factors that influence connector performance. Wire size and stranding, tin coated or bare copper, wire length & crimp quality are other factors that influence current rating

5.2.4DURABILITY WITH ENVIRONMENT:

25 cycles on EIA 364-1000.01 Group 4 Test sequence.

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PRODUCT SPECIFICATION

5.2.5 HOT-MATE/RESISTANCE TO ARC RATING SYSTEM:

Tested 8 AWG 350 VDC @ 12 volt. Conducted 50 cycle followed by T-rise max, T-rise is 30°C.

ITEM	TEST DESCR	IPTION	RESULT				
1	Initial Contact Resistance (Low Level)	6 AWG 8 AWG 10 AWG	See Table 9				
2	Dielectric Withstanding for 60 sec. @ 5mAmp max. per EIA-364-52	1,700 VAC	Pass				
3	Insulation Resistance for 60 sec. @ 500 VDC	1,000 MegOhms	Pass				
4	Current carrying Capability @ 30 degree T-Rise Per EIA-70		6 AWG 8 AWG 10 AWG	1 Ckt (Amps) 80 65 50	2 Ckt (Amps) 77 62 48	3 Ckt (Amps) 73 58 44	4-6Ckt * (Amps) 63 50 35
5	Reliability Test for 6 AWG @ 30 degree T- Rise Max (3ckt Power)	70 Amps for 4 days, current cycle for 10 days, 70 amps for 4 additional days	Stable for entire test duration (See 5.3.5 - Fig 7)				
6	Voltage Drop with Step Current applied per EIA 364, TP-06	2 Ckt. With 8 AWG Wire	16 Millivolt drop max (See 5.3.4 - Fig 6)			ig 6)	

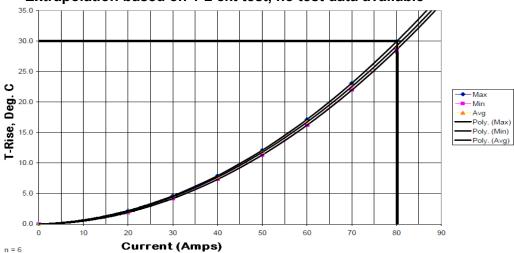
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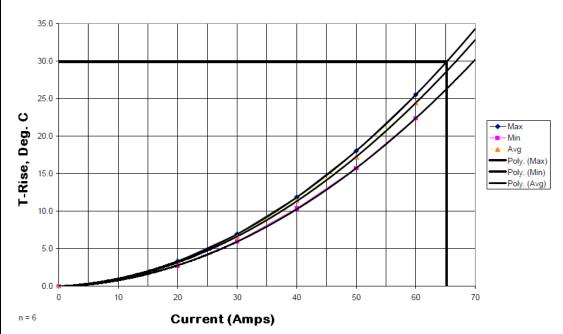
5.3 TEMPERATURE RISE& VOLTAGE DROP CHARTS

5.3.1 EPIC, 1-Circuit, 6 AWG Wire, 0.050" Cu T-Rise Current Chart

*Extrapolation based on 1-2 ckt test, no test data available



5.3.2 EPIC, 1-circuit, 8 AWG Wire, 0.032" Cu T-Rise Current Chart



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PRODUCT SPECIFICATION

5.3.3 EPIC, 1-circuit, 10 AWG Wire, 0.026" Cu T-Rise Current Chart



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PRODUCT SPECIFICATION

5.3.4 EPIC, 2-Circuit, 8 AWG Wire, 0.032" Cu Voltage Drop vs. Current

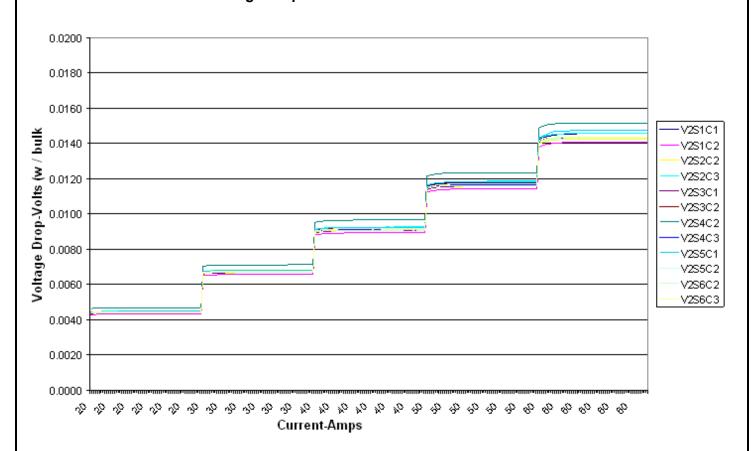
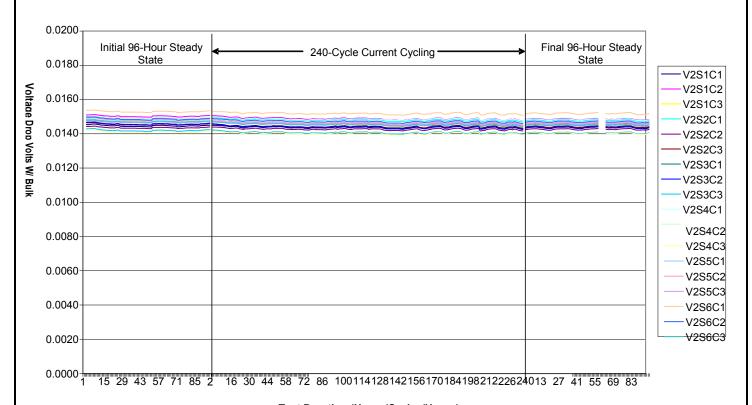


Fig. 6

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PRODUCT SPECIFICATION

5.3.5 EPIC, 3-Circuit, 6 AWG Wire, 0.032" Cu - Extended 18-Day Test Voltage Drop at 70 Amp Test Current



Test Duration (Hours/Cycles/Hours)

Fig. 7

NOTE: Current Cycle Duration is 1 hour (45 minutes on and 15 minutes off)

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PRODUCT SPECIFICATION

6.0 TEST PLAN, ENVIRONMENTAL TEST PER EIA-364-1000.01 - Table 8

Group I	Group II	Group III	Group IV	Group V
Temperature Life	Thermal Shock	Vibration	Flowing Mixed Gas	Thermal Cycling
(30 contacts)	(30 contacts)	(30 contacts)	(402 contacts)	(30 contacts)
Initial Contact	Initial Contact	Initial Contact	Initial Contact	Initial Contact
Resistance	Resistance	Resistance	Resistance	Resistance
EIA 264 22	EIA 364 33	EIA 264 22	EIA 264 22	EIA 264 22
EIA-364-23	EIA-364-23	EIA-364-23	EIA-364-23	EIA-364-23
Durability	Durability	Durability	Durability	Durability
5 cycles	5 cycles	5 cycles	5 cycles	5 cycles
_	_			
EIA-364-09	EIA-364-09	EIA-364-09	EIA-364-09	EIA-364-09
Operator Designation	Contact Desistance	Comtact Decistors	Operator at Donaintanana	On the st Denistance
Contact Resistance	Contact Resistance	Contact Resistance	Contact Resistance	Contact Resistance
Temperature Life	Thermal Shock	Temperature Life	Temperature Life	Temperature Life
105°C, 240 hours	10 cycles	105°C, 120 hours	105°C, 120 hours	105°C, 120 hours
10 Yrs @ 65°C	-55°C and +85°C	10 Yrs @ 65°C	10 Yrs @ 65°C	10 Yrs @ 65°C
EIA-364-17	EIA-364-32	EIA-364-17	EIA-364-17	EIA-364-17
O and and D and a financial	Control Designation	Control Designation	0.1.1.0	
Contact Resistance	Contact Resistance	Contact Resistance	Contact Resistance	Contact Resistance
	Cyclic Temperature	Random Vibration	Flowing Mixed Gas	
Reseating	and Humidity	Tanasin Visiation	10 days unmated	Thermal Cycling
3 cycles	·	EIA-364-28		EIA-364-1000.01
_	EIA-364-31	Condition VIID	EIA-364-65	EIA-364-1000.01
O and and D and a financial	Control Designation	Control Designation	0.1.1.0	
Contact Resistance	Contact Resistance	Contact Resistance	Contact Resistance	Contact Resistance
			Flowing Mixed Gas	
	Reseating		4 days mated	Reseating
	3 cycles			3 cycles
			EIA-364-65	
	Contact Resistance		Contact Resistance	Contact Resistance
			Thermal Disturbance	
			EIA-364-1000.01	
			Contact Desistance	
			Contact Resistance	
			Reseating	
			3 cycles	
			Contact Resistance	

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PRODUCT SPECIFICATION

7.0 TEST RESULTS, ENVIRONMENTAL TESTING - Table 9

EIA-364-TS-1000 - Group 1 Testing							
	Initial	Durability 5X	T. Life	Reseating 3X			
	mΩ	ΔmΩ	$\Delta m\Omega$	ΔmΩ			
Min	0.387	-0.010	0.001	0.002			
Max	0.649	0.008	0.024	0.032			
Avg	0.506	0.000	0.014	0.018			
St. Dev.	0.081	0.004	0.006	0.007			
n	36	36	36	36			

EIA-364-TS-1000 - Group 2 Testing						
	Initial	Durability 5X	T. Shock	C. Humidity	Reseating 3X	
	mΩ	ΔmΩ	ΔmΩ	ΔmΩ	ΔmΩ	
Min	0.419	-0.054	-0.056	-0.050	-0.039	
Max	0.681	0.155	0.163	0.156	0.162	
Avg	0.490	0.012	0.017	0.020	0.019	
St. Dev.	0.066	0.046	0.047	0.045	0.044	
n	36	36	36	36	36	

EIA-364-TS-1000 - Group 3 Testing					
	Initial	Durability 5X	T. Life	Random Vibration	
	mΩ	ΔmΩ	ΔmΩ	ΔmΩ	
Min	0.374	-0.007	0.004	-0.010	
Max	0.651	0.013	0.028	0.041	
Avg	0.524	0.001	0.017	0.009	
St. Dev.	0.073	0.004	0.005	0.011	
n	36	36	36	36	

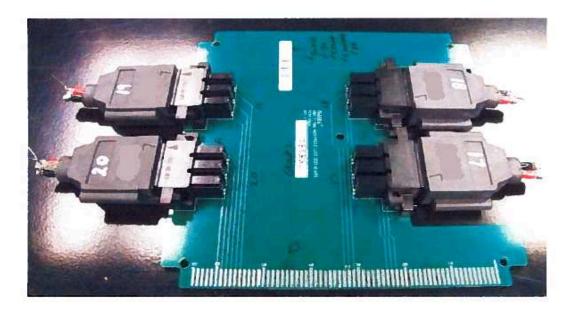
	EIA-364-TS-1000 - Group 5 Testing						
	Initial	Durability 5X	T. Life	Thermal Cycling	Reseating 3X		
	mΩ	ΔmΩ	ΔmΩ	ΔmΩ	ΔmΩ		
Min	0.343	-0.006	0.007	-0.001	0.004		
Max	0.672	0.009	0.043	0.041	0.038		
Avg	0.504	0.000	0.019	0.010	0.019		
St. Dev.	0.093	0.003	0.007	0.008	0.010		
n	36	36	36	36	36		

^{*} Note: resistance includes bulk, interface and crimp. Above resistance data includes 0.24 milliohms for Power and 0.29 milliohms for ground from wire length 7 test set-up. See sample preparation detail on page 10 of this specification.

^{**} Applied current <1.0 Amp for LLCR

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PRODUCT SPECIFICATION



Test Set-up for EIA-364-1000.01 Sequences 1, 2, 3 & 5

Fig. 10

SAMPLE PREPARATION

The headers were wave soldered onto the PC boards and cleaned in the parts washer. The plugs were common bussed so LLCR measurements could be made. Due to sample preparation there is some added bulk resistance added in the measurements. There is approximately 1.75 inches of 8 AWG for the power contacts and 1.75 inches of 10 AWG wire for the ground contacts. This contributes ~0.09 milliohms of bulk resistance to the power contact measures and ~0.144 milliohms to the ground measures. The measurement leads (pigtail) also add up to 0.15 milliohms of additional bulk for a total of around 0.24 milliohms power, and 0.29 milliohms ground (See Figure 10).

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TEMPLATE ELLENAME: PRODUCT, SPECISIZE, AVV. 4), DOC					

PRODUCT SPECIFICATION

EIA-364-1000 Test Group 4

Description: 3 circuit board mount plug and cable receptacle

Reference Information

Environmental Test Methodology... EIA-364-1000 (Test Group 4)

Contact Reliability

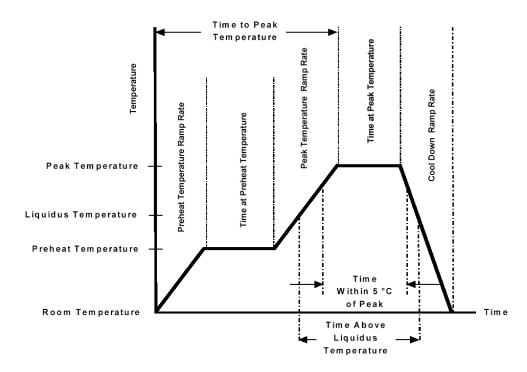
Cell	Description	Conditions	Duration	Order	Samples
1	LLCR	4-wire, dry circuit, 20 mV max		1	1-134
	Durability (pre- conditioning)	mate / unmate	5 cycles	2	all
2	LLCR	4-wire, dry circuit, 20 mV max		3	all
	Temperature Life (pre-conditioning)	105C	120 hours	4	all
3	LLCR	4-wire, dry circuit, 20 mV max		5	all
	MFG Exposure	Unmated (board mount plugs only)	10 days	6	all
4	LLCR	4-wire, dry circuit, 20 mV max		7	all
	MFG Exposure	Mated	4 days	8	all
5	LLCR	4-wire, dry circuit, 20 mV max			
	Disturbance (ATC)	15C / 85C	10 cycles	9	all
6	LLCR	4-wire, dry circuit, 20 mV max		10	all
	Reseat **	mate / unmate	3 cycles	11	all
7	LLCR **	4-wire, dry circuit, 20 mV max		12	all

REVISION:	ECR/ECN INFORMATION:	TITLE:	Guardian		SHEET No.
00	EC No: UCP2013-1403	Wire to Board Interconnect System			17 of 19
C3	DATE: 2012/10/09				
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPRO\	/ED BY:
PS-46819-001		M.KARADIMAS	M.KARADIMAS	ADIMAS A.PATEL	
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PRODUCT SPECIFICATION

8.0 SOLDERING PROFILE

(This profile is per JEDEC J-STD-020D.1 and it is for guide line only; please see notes for additional information)



Description	Requirement
Average Ramp Rate	3°C/sec Max
Preheat Temperature	150°C Min to 200°C Max
Preheat Time	60 to 180 sec
Ramp to Peak	3°C/sec Max
Time over Liquids (217°C)	60 to 150 sec
Peak Temperature	260 +0/-5°C
Time within 5°C of Peak	20 to 40 sec
Ramp - Cool Down	6°C/sec Max
Time 25°C to Peak	8 min Max

Note:

1. Temperature indicated refers to the PCB surface temperature at solder tail area.

THIS PRODUCT IS NOT DESIGNED FOR IR REFLOW PROCESS

REVISION:	ECR/ECN INFORMATION: EC No: UCP2013-1403 DATE: 2012/10/09		Guardian Wire to Board rconnect System	SHEET No. 18 of 19
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:
PS-46819-001 M.KAR		M.KARADIMAS	M.KARADIMAS	A.PATEL
TEMPLATE FILENAME: PRODUCT_SPEC[SIZE_A](V.1).DOC				

PRODUCT SPECIFICATION

9.0 SAFETY AGENCY RATING APPROVAL:

Covers product series 46817, 46818, 170351



9.1

JS File Number*: LR-19980

Single Ckt.	Current	Voltage
6 AWG	80 Amps	600 VDC
8 AWG	60 Amps	600 VDC

CSA approval meets following standards/test procedures:

a) CSA std. C22.2 No. 182.3

b) UL-1977

• - "C" and "US" mark adjacent to CSA signifies that the product has been evaluated to the applicable CSA and ANSI/UL standards, for use in Canada and US respectively.

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AWG	Voltage (V)	Current (I)
6	600 AC	80 Amps
8	600 AC	65 Amps
10	600 AC	50 Amps

Flammability - V-0

Note: Approval is at the component level.

9.2.1 Hot-Plug / Overload:

250 Volt AC @ 80 Amps tested to 25 cycles.

REVISION:	ECR/ECN INFORMATION:	TITLE: Guardian			SHEET No.
C3	EC No: UCP2013-1403	Wire to Board			19 of 19
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PS-46819-001		M.KARADIMAS	M.KARADIMAS	A.PA	TEL

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